

**OLIFF & BERRIDGE, PLC**

ATTORNEYS AT LAW

**Application Data Sheet****Application Information**

Application Type:: Regular  
Subject Matter:: Utility  
CD-ROM or CD-R: None  
Title:: BUMP STRUCTURE AND METHOD OF  
MANUFACTURING THE SAME, AND MOUNTING  
STRUCTURE FOR IC CHIP AND CIRCUIT  
BOARD  
  
Attorney Docket Number:: 119593  
Suggested Drawing Figure::  
Total Drawing Sheets:: 9  
Small Entity:: No

**Applicant Information**

Applicant Authority type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Tsuyoshi  
Family Name:: KANEKO  
City of Residence:: Shimosuwa-machi  
Country of Residence:: JAPAN

Country of Residence::

**Correspondence Information**

Correspondence Customer Number:: 25944

<b>Foreign Priority Information</b>			
Country::	Application Number::	Filing Date::	Priority Claimed::
JAPAN	2003-169051	6/13/2003	Yes
<b>Assignee Information</b>			
Assignee Name::		SEIKO EPSON CORPORATION	
Street of mailing address::		4-1, Nishishinjuku 2-chome, Shinjuku-ku,	
City of mailing address::		Tokyo	
Country of mailing address::		JAPAN	
Postal or Zip Code of mailing address::		163-0811	